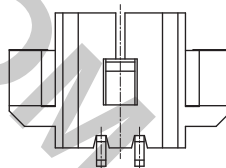
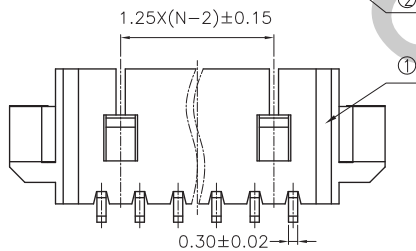
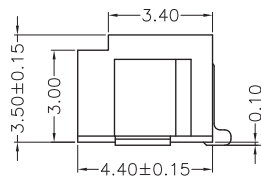
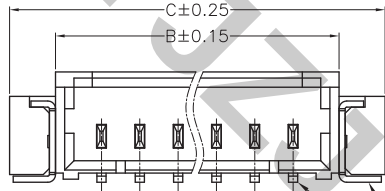
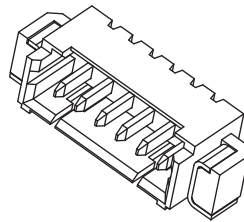
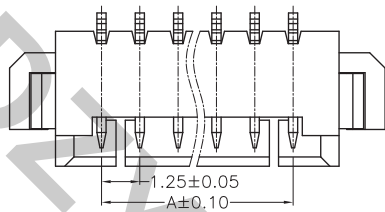
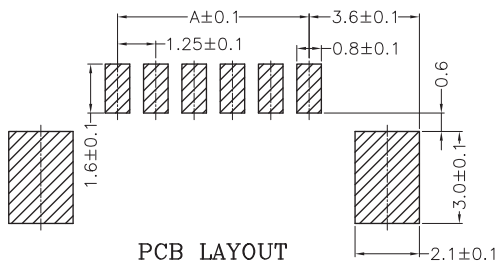


RoHS+REACH



>4P

2P&3P



PCB LAYOUT

技术指标:

1. 塑件表面应光洁、无毛边、无明显收缩、缺陷、裂纹等现象。
2. 温度范围: -25° C~85° C.
3. 额定电压: 50V, AC/DC.
4. 接触电阻: ≤40mΩ.
5. 绝缘电阻: ≥100MΩ.
6. 额定电流: 1A , AC/DC.

CKT	DimA	DimB	DimC
2	1.25	4.50	7.50
3	2.50	5.75	8.75
4	3.75	7.00	10.00
5	5.00	8.25	11.25
6	6.25	9.50	12.50
7	7.50	10.75	13.75
8	8.75	12.00	15.00
9	10.00	13.25	16.25
10	11.25	14.50	17.50
11	12.50	15.75	18.75
12	13.75	17.00	20.00
13	15.00	18.25	21.25
14	16.25	19.50	22.50
15	17.50	20.75	23.75

序号	项目	描述	备注
1	塑胶	LCP	
2	端子	黄铜	
3	焊片	黄铜	

6.0			
5.0			
4.0			
3.0			
2.0			
1.0			
REV.	DATE	DESCRIPTION	DRAWING

DRAWING:	Frank		GENERAL TOLERANCE	
			.X:=±0.30 .X*:=±2°	
			.XX:=±0.20 .XX*:=±1°	
CHECKED:	yangjie		.XXX:=±0.10 .XXX*:=±0.5°	
			UNIT: MM	PROJECTION:
			SCALE: 1/1	
APPROVAL:			SHEET: 1/1	

CHIN-BAN
Electronic Technology

DESCRIPTION:		1.25mm Wire To Board Wafer SMT	
PART NO:		REV: 1.0	
OLD CODE:	WF125UR-XXX-01		
DRAWING NO:		SIZE: A4	